

**ON Semiconductor®** 

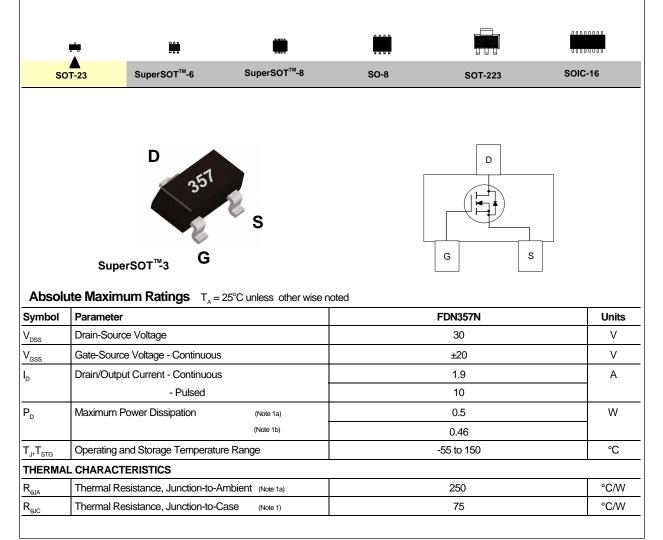
# FDN357N N-Channel Logic Level Enhancement Mode Field Effect Transistor

## **General Description**

SuperSOTTM-3 N-Channel logic level enhancement mode power field effect transistors are produced using ON Semiconductor's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage applications in notebook computers, portable phones, PCMCIA cards, and other battery powered circuits where fast switching, and low in-line power loss are needed in a very small outline surface mount package

### Features

- Industry standard outline SOT-23 surface mount package using proprietary SuperSOT<sup>™</sup>-3 design for superior thermal and electrical capabilities.
- High density cell design for extremely low R<sub>DS(ON)</sub>.
- Exceptional on-resistance and maximum DC current capability.



Symbol	Parameter	Conditions	Min	Тур	Max	Units
OFF CHAR	ACTERISTICS					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_{\rm D}$ = 250 µA, Referenced to 25 °C		36		mV/ °C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$ $T_{J} = 55^{\circ}\text{C}$			1	μA
					10	μA
I <sub>GSSF</sub>	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
I <sub>GSSR</sub>	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
ON CHARA	CTERISTICS (Note)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{\rm DS} = V_{\rm GS}, \ I_{\rm D} = 250 \ \mu A$	1	1.6	2	V
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	$I_{D}$ = 250 µA, Referenced to 25 °C		-3.6		mV/ °C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = 4.5 \text{ V}, \ I_{D} = 1.9 \text{ A}$		0.081	0.09	Ω
		T <sub>J</sub> =125°C		0.11	0.14	
		$V_{\rm GS} = 10 \text{ V}, \ I_{\rm D} = 2.2 \text{ A}$		0.053	0.06	
I <sub>D(ON)</sub>	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$	5			А
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 1.9 A$		5		S
DYNAMIC (	CHARACTERISTICS					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		235		pF
C <sub>oss</sub>	Output Capacitance			145		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			50		pF
SWITCHING	G CHARACTERISTICS (Note)					
t <sub>D(on)</sub>	Turn - On Delay Time	$V_{DD} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		5	10	ns
ţ	Turn - On Rise Time			12	22	ns
t <sub>D(off)</sub>	Turn - Off Delay Time			12	22	ns
t,	Turn - Off Fall Time			3	8	ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1.9 \text{ A},$ $V_{GS} = 5 \text{ V}$		4.2	5.9	nC
Q <sub>gs</sub>	Gate-Source Charge			1.3		nC
Q <sub>gd</sub>	Gate-Drain Charge			1.7		nC
DRAIN-SO	URCE DIODE CHARACTERISTICS AND M	AXIMUM RATINGS		1		1
l <sub>s</sub>	Maximum Continuous Drain-Source Diode For	1			0.42	Α
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{\rm GS} = 0 \ V, \ I_{\rm S} = 0.42 \ A \ ({\rm Note})$		0.71	1.2	V

1. R<sub>8.4</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>acc</sub> is guaranteed by design while  $\mathsf{R}_{_{\theta \mathsf{CA}}}$  is determined by the user's board design.

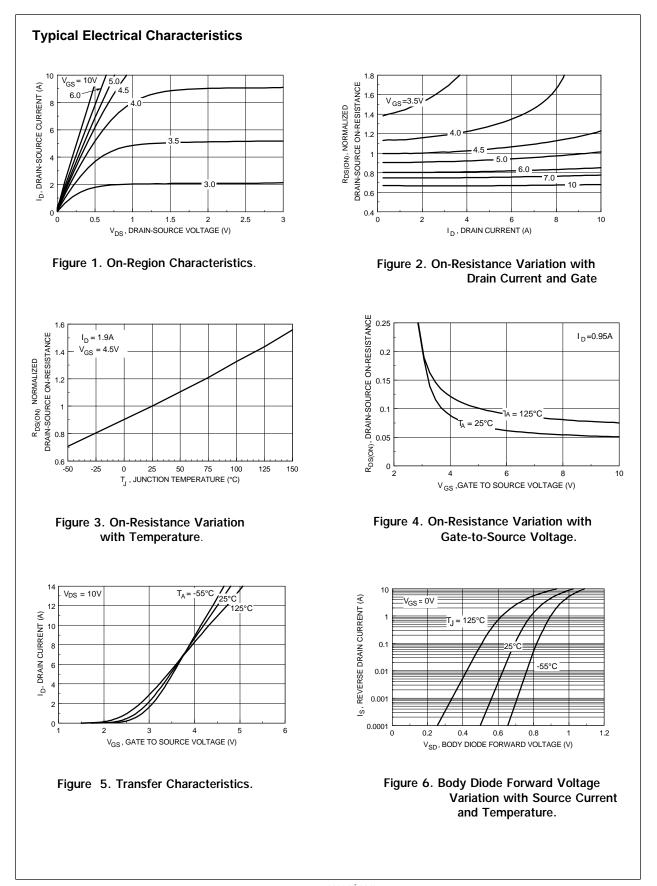
Typical  $R_{_{\rm BM}}$  using the board layouts shown below on 4.5"x5" FR-4 PCB in a still air environment :

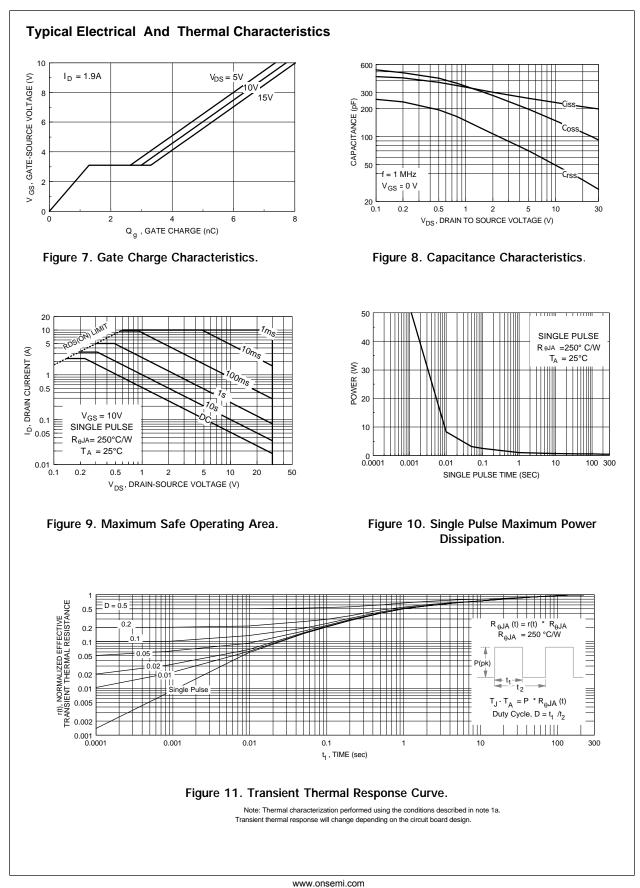


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b. 270°C/W when mounted on a 0.001 in<sup>2</sup> pad of 2oz Cu.

2. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2.0%.





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